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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/049,672	04/30/2002	Yasushi Kurata	566.411991X00	7706	
	20457 7590 07/10/2008 ANTONELLI, TERRY, STOUT & KRAUS, LLP			EXAMINER	
1300 NORTH SEVENTEENTH STREET			DEO, DUY VU NGUYEN		
	SUITE 1800 ARLINGTON, VA 22209-3873		ART UNIT	PAPER NUMBER	
			1792		
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		Application No.	Applicant(s)			
Office Action Summary		10/049,672	KURATA ET AL.			
		Examiner	Art Unit			
		Duy-Vu N. Deo	1792			
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the c	orrespondence address			
WHIC - Exter after - If NC - Failu Any (ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATES as on Soft ime may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. It is period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be time will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status						
1)[\	Responsive to communication(s) filed on 21 M	arch 2008				
•	• • • • • • • • • • • • • • • • • • • •	action is non-final.				
′=	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
٥/١	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
	closed in accordance with the practice under z	x parte Quayre, 1999 O.D. 11, 40	0.0.210.			
Dispositi	on of Claims					
4)🛛	4)⊠ Claim(s) <u>25-33,35,41,50,51,56,57,62,64-72 and 89-128</u> is/are pending in the application.					
	4a) Of the above claim(s) is/are withdrawn from consideration.					
5)	Claim(s) is/are allowed.					
6)⊠	6)⊠ Claim(s) <u>25-33, 35, 41, 50, 51, 56, 57, 62, 64-72, 89-128</u> is/are rejected.					
7)	Claim(s) is/are objected to.					
8)	Claim(s) are subject to restriction and/or	· election requirement.				
Applicati	on Papers					
•	9) The specification is objected to by the Examiner. 10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.					
10/						
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority ι	ınder 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
2) Notic 3) Inform	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	nte			

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 2. Claims 26-33, 35, 41, 50-51, 56, 57, 62, 64-72, 89-101, 104-113, 124-128 are rejected under 35 U.S.C. 102(e) as being anticipated by Lee et al. (US 6,171,352).

Lee describes a polishing composition comprising: an oxidizing agent such as H202 (col. 3, line 5; col. 6, line 44); a protective-film-forming agent of benzotriazole and/or its derivatives (col. 4, line 19); an organic acid of glycolic acid (col. 3, line 23); deionized water (col. 4, line 11); 1-15 % wt of abrasive that can be any commercially available such as silica and alumina (claimed colloidal silica and alumina) (col. 2, line

USPQ 594.

66-col. 3, line 2; col. 3, line 67-col. 4, line 1); pH is from 1-6 (col. 4, line 31-40) (this includes claimed pH of 3 or less); and the oxidizing agent concentration is from 1-15 % by weight (col. 2, line 64), this includes concentration within claimed 0.01-3 %wt or 0.01-1.5 %wt. Lee's composition includes all the claimed components; therefore, it would have a property of being capable of polishing a barrier layer of Ta, Ta alloy, or Ta compound, which is a barrier layer for a conductor of Cu, Cu alloy or Cu oxide and has a property that a ratio of a polishing rate of the barrier layer using the polishing medium,

to a polishing rate of the conductor using the polishing medium, is greater than 1 or 1.3

(claim 111) or 13.5 (claim 112). Support for this presumption is found by the facts that

the composition includes the same compounds with the same concentrations as that of

the claims. The burden is upon the applicant to prove otherwise. In re Fitzgerald, 205

Page 3

Referring to claims 27, 28, the composition further comprises polyacrylic acid copolymer or salts thereof (col. 2, line 47). This would read on claimed water-soluble polymer.

Referring to claim 35 Lee describes the method for polishing material including Cu and Ta (col. 4, line 38; col. 7, line 54).

Referring to claim 51, Lee's composition would have the polishing-rate ratio between different materials disclosed in claims 37, 38, 51, 52. Support for this presumption is found by the facts that the composition includes the same compounds with the same concentrations as that of the claims. The burden is upon the applicant to prove otherwise. In re Fitzgerald, 205 USPQ 594.

Art Unit: 1765

Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 25, 114-123, are rejected under 35 U.S.C. 103(a) as being unpatentable over Lee as applied to claims 62, 65, 69, 89, 93, 97 above, and further in view of Hardy et al. (US 6,238,592).

Lee is silent about the average size of the abrasive. Hardly describes an average particle size of 50 nm or less (col. 9, line 65-col. 10, line 5). It would have been obvious for one skill in the art to determine the particle size in light of Hardly because Hardly further describes other processing parameters, such as average size of the abrasive, that is silent in Lee and the range that has been successfully implemented in a polishing process. Even though applied prior art above does not describe standard deviation of the particle size distribution in a value of more than 5nm. It is within one skilled in the art that the particle size is a result-effective variable. Larger size would result a fast

removal rate while a smaller size would result a slower removal rate but offer a smoother surface. Therefore, one skilled in art would find it obvious to determine the particle size distribution through routine experimentation depending on the smoothness and type of material being polished.

Referring to claims 59, 65, 85, 93 Hardly fur{her teaches that the polishing medium can contain abrasive or the abrasive can be fixed to abrasive article (col. 10, line 3-7). In the latter case, the polishing medium would not contain abrasive grains.

This shows that either way would be equivalent and obvious at the time of the invention.

Referring to claims 54-57, even though applied prior art doesn't describe the pH of the oxidizing agent; however, it would be obvious to one skilled in the art that oxidizing agent pH can be any value as long as it provides the final pH of the slurry within the range as suggested by the applied prior art.

Response to Arguments

5. Applicant's argument that the applied references neither disclose or suggest claimed pH and oxidizing agent is found unpersuasive because Lee teaches the oxidizing agent concentration is from 1-15 % by weight (col. 2, line 64), this includes concentration within claimed 0.01-3 %wt or 0.01-1.5 %wt and pH is from 1-6 (col. 4, line 31-40). Since a process can only carry out at one oxidizing agent concentration and pH, Lee's teaching of 1% by weight oxidizing agent and pH at 1 or 2 would read on claimed oxidizing agent and pH.

Application/Control Number: 10/049,672

Art Unit: 1765

6. In response to applicant's argument that applied references do not teach the polishing medium has the property that it polishes the barrier layer substantially without dishing of the conductor nor the polishing medium having polishing rate ratio of Tacontaining material to the copper-containing material greater than 1, the fact that applicant has recognized another advantage which would flow naturally from following the suggestion of the prior art cannot be the basis for patentability when the differences would otherwise be obvious. See *Ex parte Obiaya*, 227 USPQ 58, 60 (Bd. Pat. App. & Inter. 1985). Furthermore, applicant has not factually shown that applied prior arts polishing medium would not necessary have the same claimed polishing rate property.

Page 6

- 7. Applicant's argument that applied prior art doesn't teach polishing medium consists essentially the recited components is found unpersuasive because those components are the main components taught by Lee described above.
- 8. Applicant points out an example from Lee using polishing medium with a pH of 3.8, which is outside of the scope of the present claims, is acknowledged. However, that is not the only pH that can be used, Lee teaches that other pHs have been successfully used such as pH is from 1-6 (col. 4, line 31-40). A pH at 1 or 2, read on claimed pH less than 3.
- 9. Applicant's argument that the Examiner has not established inherency of polishing rates, in the composition of Lee, is found unpersuasive. As discussed in the arguments section of the previous action, the Examiner has pointed out that his slurry would inherently have these properties. Support for this presumption is found by the facts that the composition includes the same compounds with the same

Art Unit: 1765

concentrations as that of the claims. The burden is upon the applicant to prove Otherwise. In re Fitzgerald, 205 USPQ 594. Applicant has not shown facts that Lee's slurry would not has the rate ratios as that of the claimed invention.

10. Referring to the limitation of having the standard deviation of particle size distribution of more than 5nm, as it is within one skilled in the art that the particle size is a result-effective variable. Larger size would result a fast removal rate while a smaller size would result a slower removal rate but offer a smoother surface. Therefore, one skilled in are would find it obvious to determine the particle size distribution through routine experimentation depending on the smoothness and type of material being polished.

Declaration

11. The Declaration by Yasushi Kurata, filed 9/6/05 is found unpersuasive because it doesn't compare the claimed subject matter with the closest prior art. See MPEP 716.02(e) [R-2]. Applicant has not shown that the polishing medium with claimed components and concentration provide an unexpected result over components and concentration of Lee's composition. It refer(s) only to the system described in the above referenced application and not to the individual claims of the application. Thus, there is no showing that the objective evidence of nonobviousness is commensurate in scope with the claims. See MPEP § 716. The system is not part of the closest applied prior art in the rejection; therefore, the Declaration doesn't address or traversed the rejection.

Conclusion

Art Unit: 1765

12. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

13.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Duy-Vu N. Deo whose telephone number is 571-272-1462. The examiner can normally be reached on Mon-Fri.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 571-272-1465. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Art Unit: 1765

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Duy-Vu N Deo/

Primary Examiner, Art Unit 1792

7/7/08